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09/782,441 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wing-Cheong G. Lai et al.

Examiner: Tuan Quach

Serial No.:

09/782,441

Group Art Unit: 2814

Filed:

February 13, 2001

Docket: 303.261US2

Title:

SMALL GRAIN SIZE, CONFORMAL ALUMINUM INTERCONNECTS AND

METHOD FOR THEIR FORMATION

AMENDMENT UNDER 37 C.F.R. § 1.312(a)

PLEASE

Mail Stop Issue Fee

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

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TU 2/10/05 In response to the Notice of Allowance and Notice of Allowability mailed May 21, 2004, please amend as follows: